UTILITY PATENT APPLICATION UNDER 37 CFR 1.53(b)

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450



Transmitted herewith for filing is the patent application of:

INVENTOR: Ryu SHIMIZU

FOR: METHOD OF MANUFACTURING A SEMICONDUCTOR INCLUDING A MULTI-LAYER INTERCONNECT STRUCTURE DEVICE

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	and the assignment of the invention to An associate power of attorney.	28 pages of specification, claims, abstract. Declaration and Power of Attorney. Priority Claimed. Certified copy of Japanese Patent Application No. 2002-287671 11 sheets of formal drawing. An assignment of the invention to and the assignment recordation fee. An associate power of attorney. A verified statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.9 Return Receipt Postcard

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Respectfully submitted,

MCDERMOTT, WILL & EMERY

Registration No. 26,106

600 13th Street, N.W. Washington, DC 20005-3096 (202) 756-8000 AJS:tlb Facsimile: (202) 756-8087

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